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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10067240	FILING DATE 02/07/2002	CLASS 424 295	SUBCLASS 38607	GAU 1778 4741	EXAMINER H. J. Zimmerman
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****APPLICANTS:** Yamamoto Takuya; Kataoka Takashi; Hirasawa Yutaka; Takahashi, Naotomi;

****CONTINUING DATA VERIFIED:**

**** FOREIGN APPLICATIONS VERIFIED:**

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed	<input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 119 conditions met	<input type="checkbox"/> yes <input type="checkbox"/> no	108384-00041
Verified and Acknowledged Examiners's initials		
TITLE : Surface treated copper foil, electrodeposited copper foil with carrier, manufacture method for the electrodeposited copper foil with carrier, and copper clad laminate		

U.S. DEPT. OF COMM. / PAT. & TM-PTO-435L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner			
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
Primary Examiner		Application Examiner	
<input type="checkbox"/> TERMINAL		PREPARED FOR ISSUE	
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